

Information and Communication Technologies for Precision Agriculture: SuPPReSS Case Study

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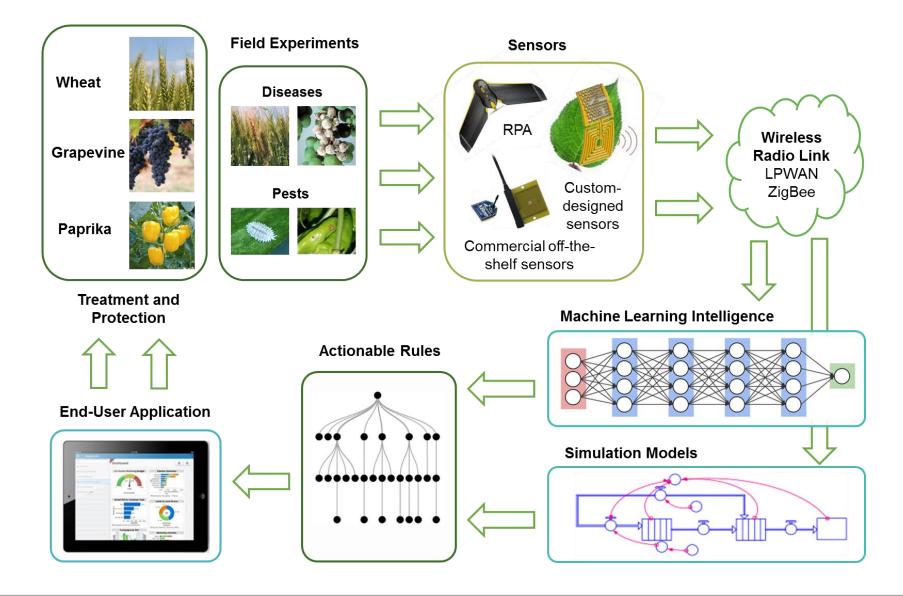
22nd INTERNATIONAL SYMPOSIUM ON BIOTECHNOLOGY



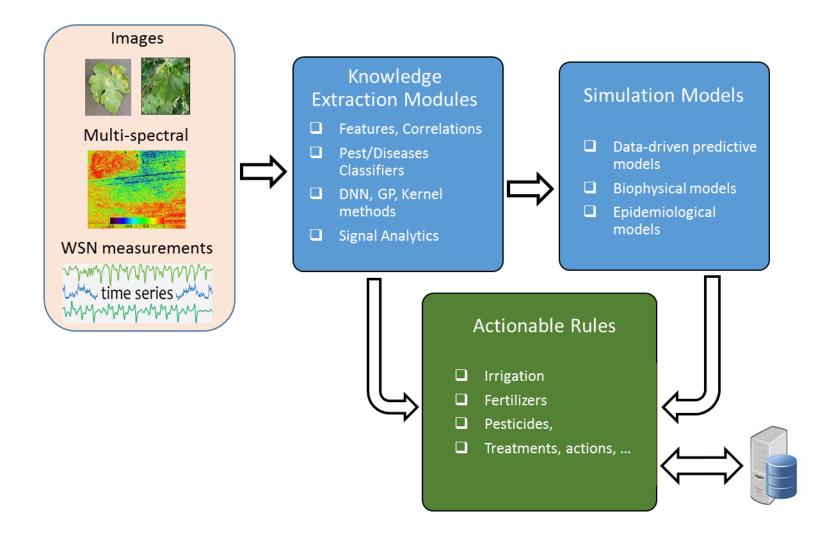
innovations for high performance microelectronics



SuPPReSS Technology (1)



SuPPReSS Technology (2)



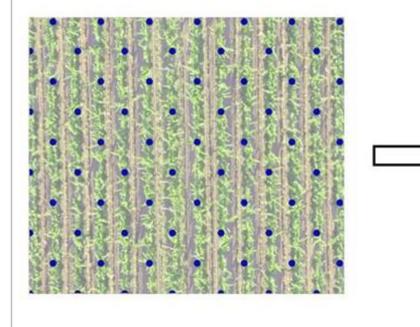
Simulation Model Inputs - Variables

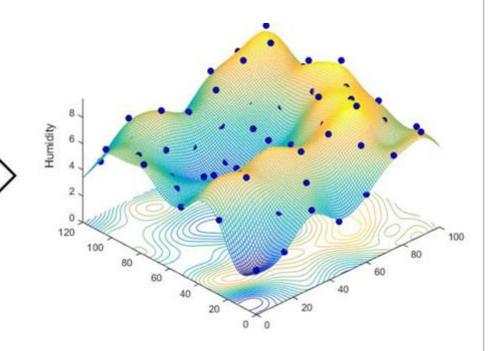
Variables	Wheat	Grapevine	Pepper	
Meteorological variables	Temperature, humidity, rainfall, wind speed, and insolation	Temperature, humidity, rainfall, wind speed, and insolation	Temperature, humidity, rainfall, wind speed, insolation, and atmospheric CO ₂ concentration	
Crop variables	Phenology, above- ground biomass	Phenology, above- ground biomass	Phenology, above-ground biomass, partitioning of biomass into crop organs	
Management information	Previous crop, variety, cropping practices, fertilization, and harvest date	Variety, cropping practices, irrigation rate, fertilization, and harvest date	Previous crop, variety, cropping practices, irrigation rate, fertilization, harvest date	
Pest and disease effects	Yield loss caused by disease, infected leaf area (STB) or heads (FHB)	Percentage of grapes, leafs and stems affected by disease	Number of dropped fruits and destroyed plants, percentage of crops affected by pests	
Soil variables	Soil moisture (at specific depth), soil texture, and organic matter content	Soil moisture (at 5 cm and 20 cm depth)	Moisture, clay, sand, organic matter content, C to N ratio, pH (CaCl ₂), Ca content	
Nutrients concentration	Nitrogen concentration in leaves	Nitrogen concentration in leaves	N and Ca in leaves and fruits	
Leaf variables	Leaf wetness and temperature, leaf area index	Leaf wetness and temperature, leaf area index	Leaf wetness and temperature, leaf area index	
Quality	DON (deoxynivalenol) concentration	Colour, sugar, acidity and pH in fruit juice	Sugar, acid, and capsaicin content in hot varieties, vitamin C, total phenols, and phenolic acids	

Images	Wheat		Grapevine		Pepper	
	FHB	STB	Mildew	Citrus mealybug	CBW/ECB	GPA
Multispectral data taken from RPA (four spectral bands)	Bleached heads	Long- stretched patterns	Yellowish patterns on the upper surface of leaves	Leaf-roll Defoliation		
Thermal data taken from RPA (four spectral bands)	Bleached heads	Discoloured leaves Necrotic area Chlorotic area around lesions	Yellowish patterns on the upper surface of leaves	Leaf-roll Defoliation		
RGB images	Portion of head infected	Portion of leaf area diseased	Portion of non-green leaf area	Portion of non-green leaf area	Larvae on stem and fruits Egg on both sides of leaf Position of fruits and dropped fruits	Colony on plant tips Ant colony Fruit colour and shape Portion of non-green leaf area
Trap photos				Sticky bases	Sticky bases	Yellow traps

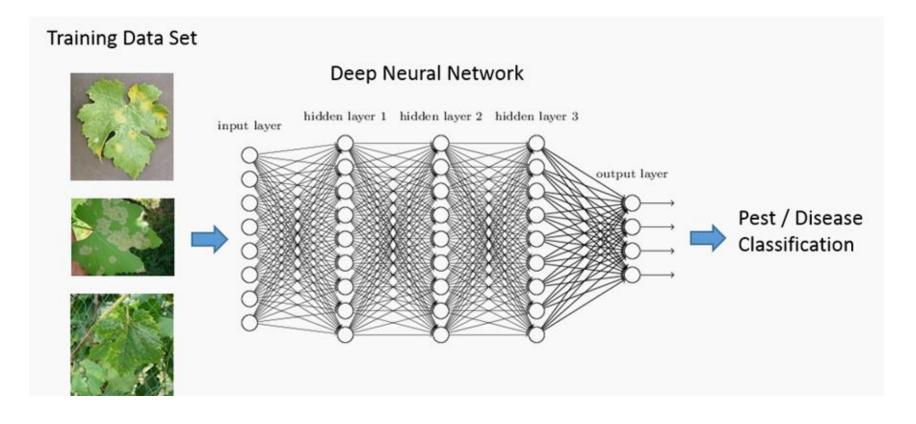
Gaussian Processes

For regression/interpolation problems in spatio-temporal fields Measure of the similarity between points (this is the kernel function) Predict the value for an unseen point from training data Prediction is the estimate for unseen point with uncertainty information

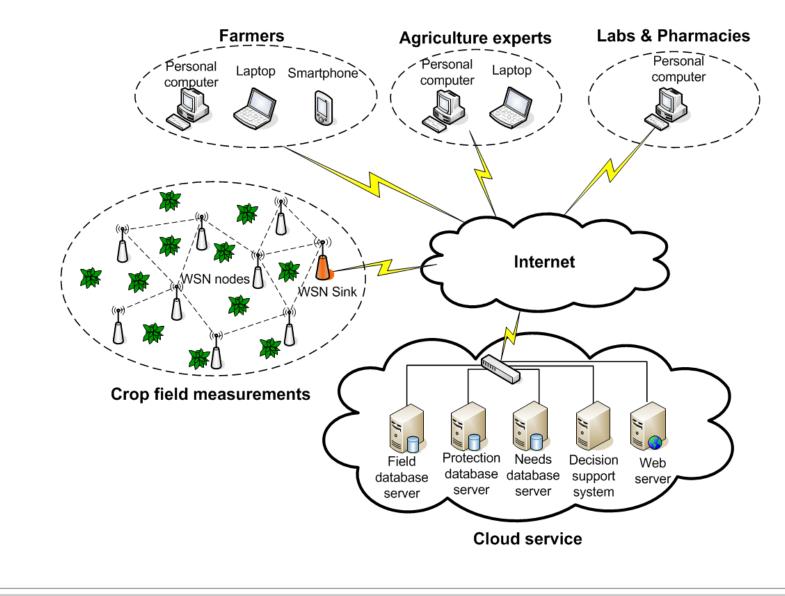




Cascade of multiple layers of simple nonlinear processing units Weights of interconnections are adjusted during network training



SuPPReSS Decision Support System



Wireless Sensor Nodes - Properties

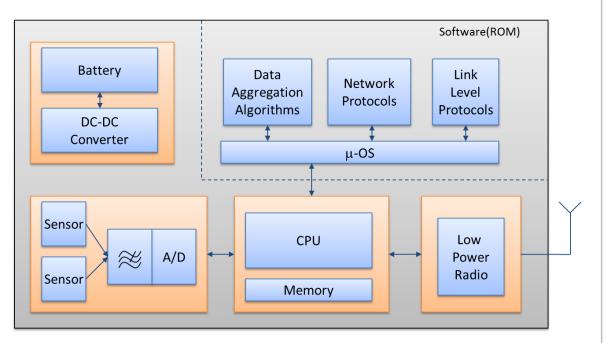
Lifetime operation with a single battery charge

- **Diversity of applications**
- Low duty cycle

Small size

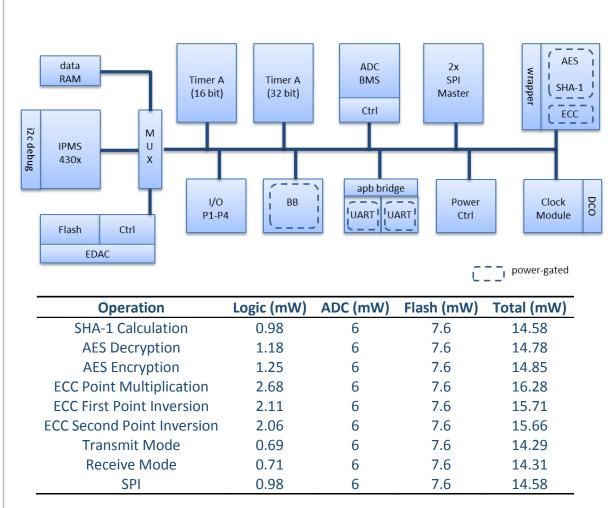
Low cost

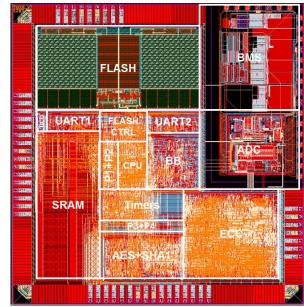




Design challenges: energy consumption vs performance vs cost

TNODE Processor



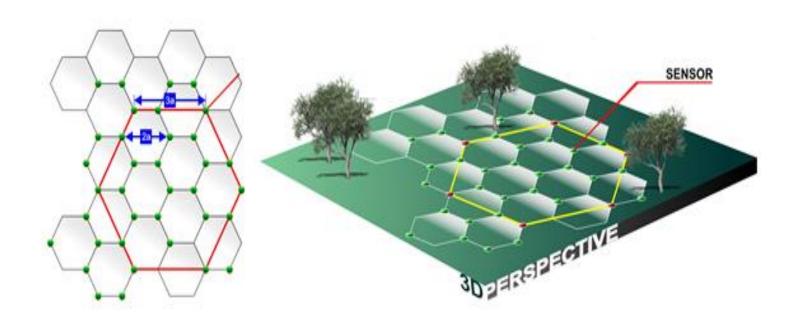


Technology: 250 nm BiCMOS			
Area: 31 mm²			
Pads: 71			
Frequency: 11.4 MHz			
Peak Power at 1 MHz:			
52 mW (ADC on)			
10 mW (ADC off)			

G. Panic, O. Stecklina, and Z. Stamenkovic, "An Embedded Sensor Node Microcontroller with Crypto-Processors", Sensors, vol.16, pp.60701-60719, 2016.

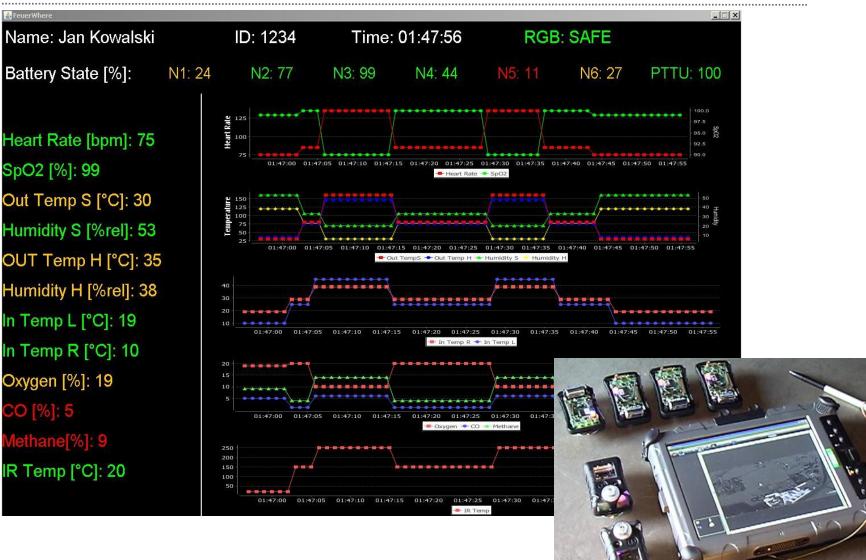
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Sensor Deployment



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Demonstrator





Thank you for your attention!

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